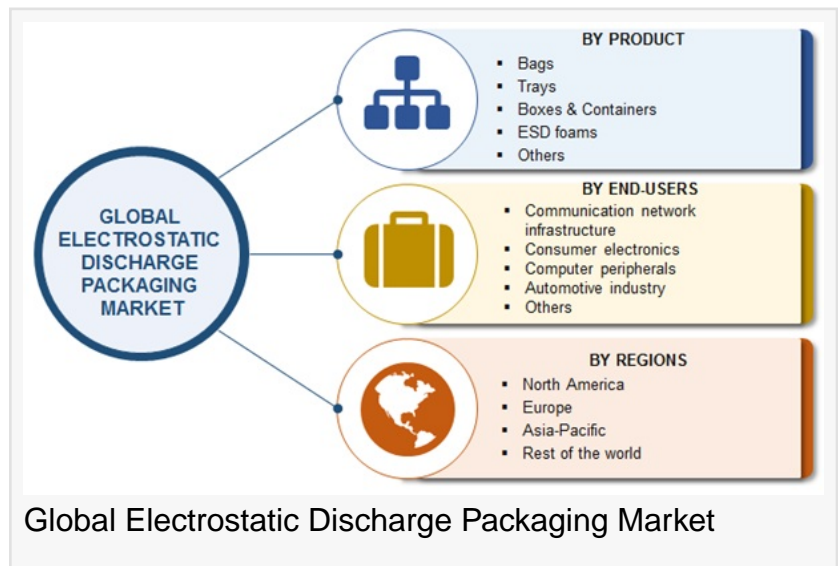


# Electrostatic Discharge Packaging Market is Predicted to Grow Approximately at 8.2% CAGR by 2023

Market Research Future published a half-cooked research report on *Global Electrostatic Discharge Packaging Market Research Report Market Analysis, Scope & Stake*

PUNE, MAHARASHTRA, INDIA, June 16, 2017 /EINPresswire.com/ -- [Global Electrostatic Discharge Packaging Market](#) by Product (Bags, Trays, Boxes & Containers, ESD foams, others), by end-users (Communication network infrastructure, Consumer electronics, Computer peripherals, Automotive industry, others), by Region (Asia-Pacific, North America, Europe, Row)



The [Electrostatic discharge packaging](#) is also called as antistatic packaging. Static can be caused by various factors such as including other devices, friction or even the weather. Electrostatic discharge packaging is vital for the safe transportation and storage of most electronic products. Also, the operational requirement among original equipment manufacturers to isolate ESD sensitive items, components and devices during manufacturing, assembling and shipping has led to such specific packaging need catered by packaging manufacturers.

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Asia-Pacific region is expected to dominate the [electrostatic discharge packaging market](#) with the highest CAGR, owing to factors such as growing demand for smartphones and IT infrastructure. The developing economies such as China and India are the major contributors to the growth of the market in the region. In addition, government initiatives such as Digital India is expected to propel the usage of smartphones in the country, as a result boosting the growth of electrostatic discharge packaging market.

This study provides an overview of the global electrostatic discharge packaging market, tracking two market segments across four geographic regions. The report studies key players, providing a five-year annual trend analysis that highlights market size, volume and share for Asia-Pacific, North America, Europe and Rest of the World (ROW). The report also provides a forecast, focusing on the market opportunities for the next five years for each region. The scope of the study segments the global electrostatic discharge packaging market by its product, end-users and region.

## By Product

- Bags
- Trays

- Boxes & Containers
- ESD foams
- Others

#### By End-users

- Communication network infrastructure
- Consumer electronics
- Computer peripherals
- Automotive industry
- Others

#### By Region

- Asia Pacific
- North America
- Europe
- Rest of World

#### Key Players

- Teknis Limited (U.K.)
- Tandem Equipment Sales, Inc. (U.S.)
- Summit Packaging Solutions (U.S.)
- Stephen Gould Corp. (U.S.)
- Statico (U.S.)
- Elcom UK Ltd (U.K.)
- Protektive Pak (U.S.)
- GWP Group Limited (U.K.)
- Desco Industries Inc. (U.S.)

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Asia-Pacific is expected to dominate the electrostatic discharge packaging market during the forecast period. The presence of huge number of electronic manufacturers in countries like China, Japan, South Korea and Taiwan is the major driver for the growth of electrostatic discharge packaging market in the region. Asia Pacific is expected to be followed by Europe and North America, where the contribution of U.S. is anticipated to be more.

#### Target Audience

- Manufactures
- Raw Materials Suppliers
- Aftermarket suppliers
- Research Institute / Education Institute
- Potential Investors
- Key executive (CEO and COO) and strategy growth manager

The report for Global Electrostatic Discharge Packaging Market of Market Research Future comprises of extensive primary research along with the detailed analysis of qualitative as well as quantitative aspects by various industry experts, key opinion leaders to gain the deeper insight of the market and industry performance. The report gives the clear picture of current market scenario which includes historical and projected market size in terms of value and volume, technological advancement, macro economical and governing factors in the market. The report provides details information and strategies of the top key players in the industry. The report also gives a broad study of the different market segments and regions.

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